

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT																								
NATURE OF CONVEYANCE:	ASSIGNMENT																								
CONVEYING PARTY DATA																									
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CORRESPONDENCE DATA																									
Fax Number:	7032058050																								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>																									
Phone:	7032058000																								
Email:	mailroom@bskb.com, mussie.beyene@bskb.com																								
Correspondent Name:	BIRCH, STEWART, KOLASCH, & BIRCH, LLP.																								

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Address Line 1: P.O. BOX 747
Address Line 4: Falls Church, VIRGINIA 22040-0747

ATTORNEY DOCKET NUMBER:	0941-2741PUS1
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NAME OF SUBMITTER:	Mussie B. Beyene
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ASSIGNMENT

WHEREAS, Chih-Cherng LIAO, Yun-Chou WEI, Pi-Kuang CHUANG, Ching-Yi HSU, Chih-Wei LIN, Wen-Chung CHEN, Che-Hua CHANG, Yung-Lung CHOU, Chung-Te CHOU, Cheng-Lun CHO, and Ya-Han LIANG hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: HIGH VOLTAGE SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE SAME

Filed: March 18, 2013 Serial No. 13/846,657

Executed on: March 5, 2013

WHEREAS, Vanguard International Semiconductor Corporation of 123, Park Ave-3rd, Science - Based Industrial Park, Hsinchu, Taiwan 30077, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Chih-Cherng Liao
Chih-Cherng LIAO

3/5/2013
Date

Yun-Chou Wei
Yun-Chou WEI

3/5/2013
Date

ASSIGNMENT

Pi-Kuang Chuang

Pi-Kuang CHUANG

3/5/2013

Date

Ching-Yi HSU

Ching-Yi HSU

3/5/2013

Date

Chih-Wei Lin

Chih-Wei LIN

3/5/2013

Date

Wen-Chung Chen

Wen-Chung CHEN

3/5/2013

Date

Che-Hua Chang

Che-Hua CHANG

3/5 - 2013

Date

Yung-Lung Chou

Yung-Lung CHOU

3/5 - 2013

Date

Chung-Te CHOU

Chung-Te CHOU

3/5/2013

Date

†

cheng - Lun CHO

Cheng-Lun CHO

3/5 / 2013

Date

Ya-Han Liang

Ya-Han LIANG

3/5 / 2013

Date